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Cybersecurity — Security considerations throughout the product life cycle

Cybersécurité — Considérations relatives à la sécurité tout au long du cycle de vie du produit

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Foreword

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Introduction

The globalization of technology design, development, manufacturing, and distribution has created an environment of complicated supply chains with limited transparency. This presents an incredible challenge for the industry and highlights a growing need to ensure product integrity for all stages of the information and communications technology (ICT) product life cycle.

The call for assurance across the supply chain landscape has evolved over several decades. More recently, policy makers around the world have begun to focus on supply chain risks in new ways: from policies considering supply chain security risks for government procurement to various initiatives adding security considerations such as trust and transparency in the supply chain for ICT.

Vendors have been doing their part as well. Over the past several years, ICT suppliers have taken important steps towards increasing supply chain transparency. These steps include sourcing conflict-free minerals,[1] and implementing a set of policies, procedures and tools at factories to improve security consideration throughout the supply chain by validating where and when each component of an ICT product was manufactured.

These are important first steps, however they primarily focus on the production stage, just one stage of the ICT product life cycle. In today's complex environment, hardware platform providers are expected to enable a full range of tools and solutions that improve security consideration across the entire life cycle, from design and sourcing to secure retirement.

Security considerations throughout the product life cycle (SCLC) establish an end to end framework that can be applied to the multi-year life cycle of ICT products to comprehend and address potential risks for improved transparency and higher levels of security assurances. By enabling transparency and assurances across the ICT product life cycle, supply chain owners can improve platform integrity, resilience and security. The life cycle phases are both iterative and recursive in nature.

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Cybersecurity — Security considerations throughout the product life cycle

1 Scope

This document describes security considerations throughout the product life cycle (SCLC), which is a framework that spans the entire information and communications technology (ICT) product life cycle. The aim of the framework is to align the industry and bring greater transparency to customers at every point on the ICT product life cycle.

This document describes the following items for suppliers, end users (consumers), intermediaries of the ICT supply chain, service providers, and regulators:

— definition of phases in the ICT product life cycle from concept to retirement;

— threat vectors possible in each phase of the life cycle;

— potential controls against those threat vectors.

The target audiences of this document are suppliers and consumers of ICT products, including all participants throughout the supply chain such as silicon chip designers, fabricators, product assemblers, logistics providers, service providers, and information security organizations. Clauses 5 to 11 target an organization's strategic and risk management teams. This document provides an end-to-end view of the threats in each phase to help the organization shape their plans, procedures and policies.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

ISO/IEC/IEEE 15288, *Systems and software engineering — System life cycle processes*

ISO/IEC/IEEE 24748-1:2018, *Systems and software engineering — Life cycle management — Part 1: Guidelines for life cycle management*

3 Terms and definitions

For the purposes of this document, the terms and definitions given in ISO/IEC/IEEE 15288, ISO/IEC/IEEE 24748-1:2018, and the following apply.

ISO and IEC maintain terminology databases for use in standardization at the following addresses:

— ISO Online browsing platform: available at https://www.iso.org/obp

— IEC Electropedia: available at https://www.electropedia.org/

3.1
digital signature
data appended to, or a cryptographic transformation of, a data unit that allows the recipient of the data unit to verify the source and integrity of the data unit

[SOURCE: ISO/IEC 9798-3:2019, 3.3]

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